

CT0402L14UG

#### **SMD Multilayer Varistor with Nickel Barrier Termination**

B72590T0140L960

PRELIMINARY DATA SHEET

(parameters may be changed if necessary)

## **Designation System**

CT = **C**hip with **T**hree-layer-termination

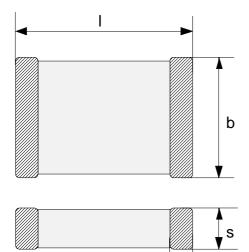
0402 = Dimensions of the device  $\underline{04} \times \underline{02}$  (Length x width in 1/100 inch)

L = Tolerance of the varistor voltage (± 15 %)

14 = Max. operating voltageU = Ultra Low DC Leakage

G = Taped version, cardboard tape, 7" reel (10000 pcs/reel)

# **Figure**



 $l = 1.0 \pm 0.15$  $b = 0.5 \pm 0.10$ 

 $s = 0.5 \pm 0.10$  $k = 0.2 \pm 0.10$ 

(All dimensions in mm)

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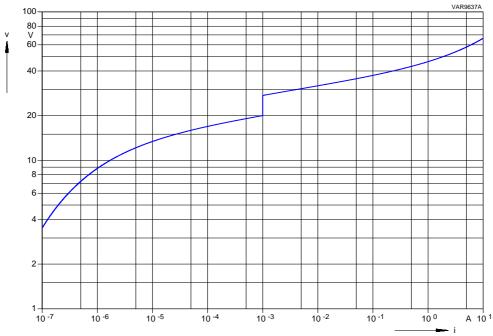
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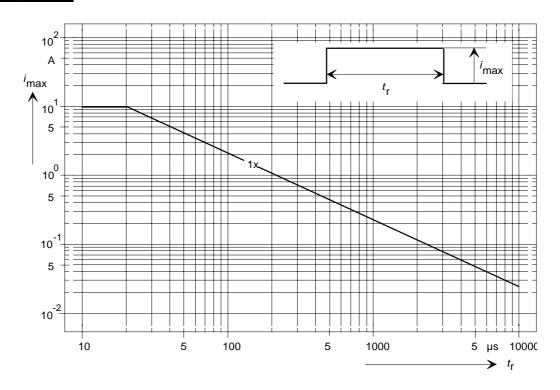
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# **V-I Characteristic**



# **Derating Field**



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### **Electrical Data**

Max. operating voltage

RMS voltage  $V_{eff} = 14 V$  DC voltage  $V_{DC} = 16 V$ 

Varistor voltage (@ 1 mA)  $V_V = 20 - 27 V$ 

Max. clamping voltage (@ 1 A)  $V_C = 46 V$ 

Max. DC leakage current (@3.5V, 25°C) Is =  $0.1\mu$ A

Max. average power dissipation  $P_{max} = 3 \text{ mW}$ Max. surge current (8/20  $\mu$ s)  $\hat{I}_{max} = 1 \text{ x 10 A}$ Max. energy absorption (2 ms)  $E_{max} = 1 \text{ x 0.01 J}$ Max. energy absorption (ESD)  $E_{max} = 30 \text{mJ}$ 

(@ ESD acc. IEC61000-4-2, 15kV Air Discharge, 150pF, 330 Ω)

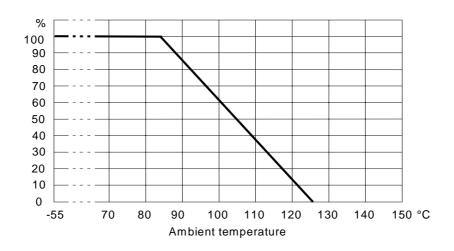
Capacitance (@ 1 MHz, 1 V, 25°C; typical) 47 pF

Response time < 0.5 ns

Operating temperature -55 ... +85 °C
Storage temperature (mounted parts) -55 ... +125 °C

#### **Derating Curve:**

Max. current, energy, operating voltage and average power dissipation depending on ambient temperature



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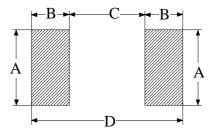
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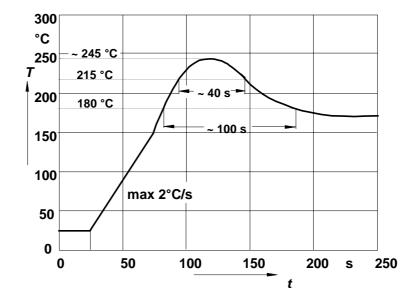
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### **Recommended Geometry of Solder Pads**



A = 0.6 mm B = 0.6 mm C = 0.5 mm D = 1.7 mm

### **Recommended Soldering Temperature Profiles**



Max. reflow cycles: 3

The components should be soldered within 12 months after delivery from EPCOS. The parts are to be left in the original packing in order to avoid any soldering problems caused by oxidized terminals.

Storage temperature: -25 to 45°C.

Relative humidity: <75% annual average, <95% on max. 30 days in a year.

The usage of mild, non activated fluxes for soldering is recommended, as well as proper cleaning of the PCB.

The components are suited to Pb-free soldering.

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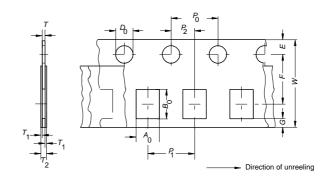
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# Taping according to 60286-3

Dimensions and tolerances

Tape material: cardboard



Definition	Symbol	Dim.	Tolerance
Compartment width	$A_0$	0.6	± 0.2
Compartment length	$B_0$	1.15	± 0.2
Sprocket hole diameter	$D_0$	1.5	± 0.1
Sprocket hole pitch	$P_0$	4.0	± 0.1 <sup>1)</sup>
Distance center hole to center compartment	$P_2$	2.0	± 0.05
Pitch of the component compartments	P <sub>1</sub>	2.0	± 0.1
Tape width	W	8.0	± 0.3
Distance edge to center of hole	E	1.75	± 0.1
Distance center hole to center compartment	F	3.5	± 0.05
Distance compartment to edge	G	0.75	min
Thickness of cardboard tape	Т	0.6	max.
Overall thickness	$T_2$	0.7	max.

 $<sup>^{1)} \</sup>le \pm 0.2$  mm over any 10 pitches

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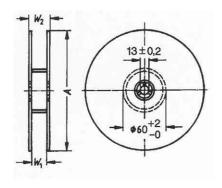
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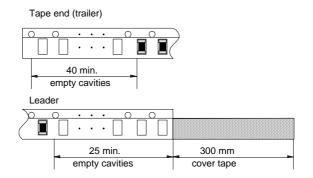
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#### Package 8 mm tape:





Reel material: plastic

Definition	Symbol	Dimension	Tolerance
		[mm]	[mm]
Reel diameter	А	180	+0 / -3
Reel width (inside)	$W_1$	8.4	+1.5 /-0
Reel width (outside)	$W_2$	14.4	max.

# **Package**

Dimensions approx. 220 x 200 mm. Weight approx. 170 g

6 bags in cardboard box; dimensions approx. 250 x 220 x 130 mm, weight approx. 1 kg.

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